### 505646018 08/29/2019

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

Version v1.1 EPAS ID: PAT5692824

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIROKI AKASE	08/01/2019
MASAHIKO IIJIMA	08/01/2019
CHIE YABUTANI	08/01/2019
TAKANORI SAWADA	08/01/2019
REI KONISHI	08/01/2019

#### **RECEIVING PARTY DATA**

Name:	: HITACHI HIGH-TECHNOLOGIES CORPORATION	
Street Address:	reet Address: 24-14, NISHI-SHIMBASHI 1-CHOME	
City:	MINATO-KU, TOKYO	
State/Country:	JAPAN	
Postal Code:	105-8717	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16488182

### **CORRESPONDENCE DATA**

**Fax Number:** (703)610-8686

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 7039039000

**Email:** ipdocketing@milesstockbridge.com,

kswanson@milesstockbridge.com

Correspondent Name: ERIC G. KING

Address Line 1: MILES & STOCKBRIDGE PC

Address Line 2: 1751 PINNACLE DRIVE, SUITE 1500 Address Line 4: TYSONS CORNER, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	T6949-23512US01
NAME OF SUBMITTER:	KRYSTAL SWANSON
SIGNATURE:	/Krystal Swanson/
DATE SIGNED:	08/29/2019

**Total Attachments: 3** 

PATENT REEL: 050208 FRAME: 0401

505646018

source=Assignment T6949-23512US01#page1.tif source=Assignment T6949-23512US01#page2.tif source=Assignment T6949-23512US01#page3.tif

> PATENT REEL: 050208 FRAME: 0402

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me, by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo 1058717, Japan, receipt of which is hereby acknowledged, I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### AUTOMATIC ANALYSIS DEVICE AND AUTOMATIC ANALYSIS METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

(署名日)

Date Signed
(署名日)

(署名日)

Marchi Mase
Hiroki AKASE

August 1 2019

# INVENTOR(S) (発明者フルネームサイン)

Date Signed (署名日)

3)	Chie Yabutani	August 1, 2019
	Chie YABUTANI	
<sup>4)</sup> —		
	Takanori SAWADA	
5)	Rei KONISHI	August 1, 2019
_	Rei KONISHI	

## INVENTOR(S) (発明者フルネームサイン)

# Date Signed (署名日)

3)		
	Chie YABUTANI	-
	T 1 / L	1 12019
)	Takanori Sawada	Aug. 1. 2019
	Takanori SAWADA	
		<u> </u>
-3*	Rei KONISHI	